Product Datasheet

AFBR-79EIDZ-FT1-C

Avago Broadcom® Compatible 40Gb/s QSFP SR4 QSFP Transceiver

Hot Pluggable, MTP/MPO Connector, +3.3V, MMF 150M DDM 0~70C

FEATURES

- 4 independent full-duplex channels
- Up to 11.2Gbps per channel bandwidth
- Aggregate bandwidth of > 40Gbps
- MTP/MPO optical connector
- QSFP MSA compliant
- Digital diagnostic capabilities
- CML compatible electrical I/O
- Single +3.3V power supply operating
- TX input and RX output CDR retiming
- Built-in digital diagnostic functions
- Temperature range 0°C to 70°C
- RoHS Compliant Part

APPLICATIONS

- Rack to rack
- Data Centre
- Metro networks
- Switches and Routers
- Infini band 4x SDR, DDR, QDR

DESCRIPTION

ATGBICS® AFBR-79EIDZ-FT1-C is a parallel 40Gbps Quad Small Form-factor Pluggable (QSFP) optical module that provides increased port density and total system cost savings. The QSFP full-duplex optical module offers 4 independent transmit and receive channels, each capable of 10Gbps operation for an aggregate bandwidth of 40Gbps 70m on OM3 Multimode Fiber (MMF)and 150m on OM4 MMF.

An optical fiber ribbon cable with an MPO/MTP connector at each end plugs into the QSFP module receptacle. The orientation of the ribbon cable is “keyed” and guide pins are present inside the module’s receptacle to ensure proper alignment. The cable usually has no twist (key up to key up) to ensure proper channel to channel alignment. Electrical connection is achieved through a z-pluggable 38-pin IPASS® connector.

ATGBICS®

Product Datasheet

The module operates from a single +3.3V power supply and LVCMOS/LVTTL global control signals such as Module Present, Reset, Interrupt and Low Power Mode are available with the modules. A 2-wire serial interface is available to send and receive more complex control signals and to obtain digital diagnostic information. Individual channels can be addressed, and unused channels can be shut down for maximum design flexibility.

The AFBR-79EIDZ-FT1-C is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP Multi-Source Agreement (MSA). It has been designed to meet the harshest external operating conditions including temperature, humidity and EMI interference. The module offers very high functionality and feature integration, accessible via a two-wire serial interface.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit
Storage Temperature	T_S	-40		+85	°C
Supply Voltage	$V_{CC}T, R$	-0.5		4	V
Relative Humidity	RH	0		85	%

Recommended Operating Environment

Parameter	Symbol	Min.	Typical	Max.	Unit
Case operating Temperature	T_C	0		+70	°C
Supply Voltage	$V_{CCT, R}$	+3.13	3.3	+3.47	V
Supply Current	I_{CC}			1000	mA
Power Dissipation	PD			3.5	W

ATGBICS®

Product Datasheet

Electrical Characteristics

Parameter	Symbol	Min	Typ	Max	Unit	Note
Data Rate per Channel		-	10.3125	11.2	Gbps	
Power Consumption		-	2.5	3.5	W	
Supply Current	Icc		0.75	1.0	A	
Control I/O Voltage-High	VIH	2.0		Vcc	V	
Control I/O Voltage-Low	VIL	0		0.7	V	
Inter-Channel Skew	TSK			150	Ps	
RESETL Duration			10		Us	
RESETL De-assert time				100	ms	
Power On Time				100	ms	
Transmitter						
Single Ended Output Voltage Tolerance		0.3		4	V	1
Common mode Voltage Tolerance		15			mV	
Transmit Input Diff Voltage	VI	120		1200	mV	
Transmit Input Diff Impedance	ZIN	80	100	120		
Data Dependent Input Jitter	DDJ			0.1	UI	
Data Input Total Jitter	TJ			0.28	UI	
Receiver						
Single Ended Output Voltage Tolerance		0.3		4	V	
Rx Output Diff Voltage	Vo		600	800	mV	
Rx Output Rise and Fall Voltage	Tr/Tf			35	ps	1
Total Jitter	TJ			0.7	UI	
Deterministic Jitter	DJ			0.42	UI	

Note:
1. 20 – 80 %

ATGBICS®

Product Datasheet

Optical Parameters

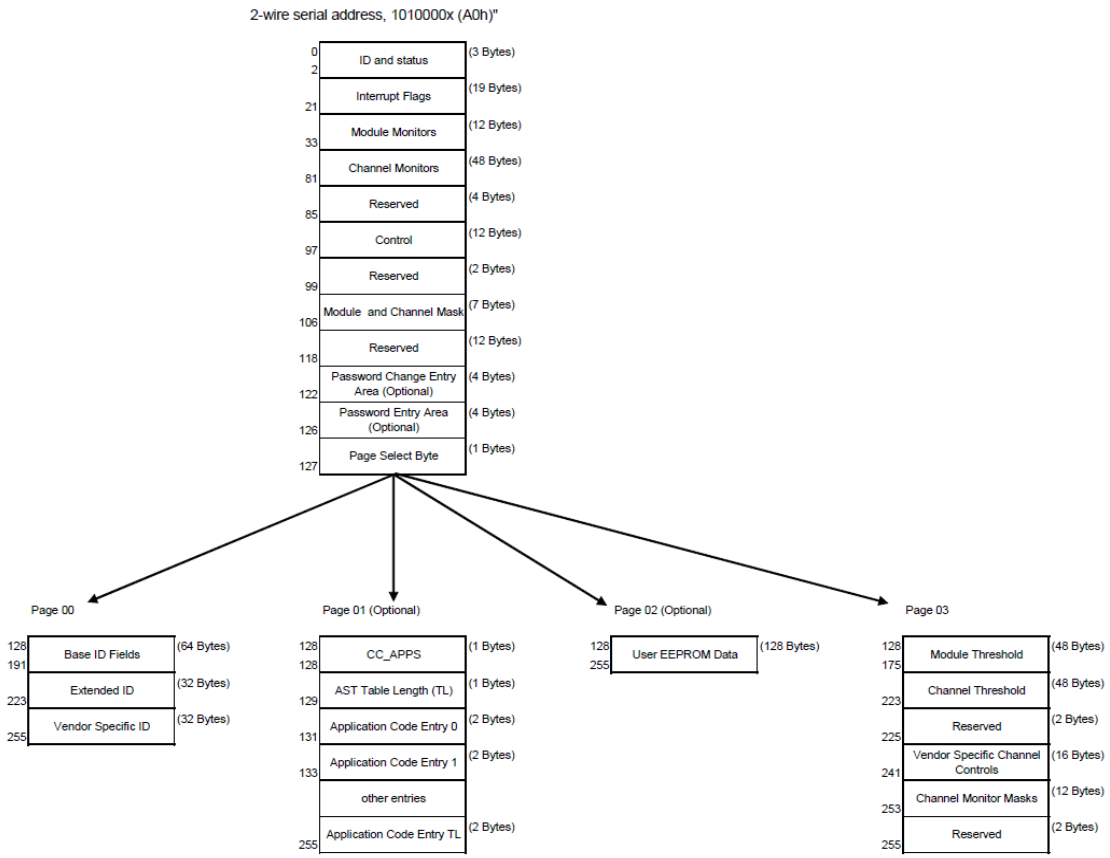
Parameter	Symbol	Min	Typ	Max	Unit	Ref.
Transmitter						
Optical Wavelength	λ	840		860	nm	
RMS Spectral Width	Pm		0.5	0.65	nm	
Average Optical Power per Channel	Pavg	-8	-2.5	+1.0	dBm	
Laser Off Power Per Channel	Poff			-30	dBm	
Optical Extinction Ratio	ER	3.5			dB	
Relative Intensity Noise	Rin			-128	dB/HZ	1
Optical Return Loss Tolerance				12	dB	
Receiver						
Optical Center Wavelength	λ_C	840		860	nm	
Receiver Sensitivity per Channel	R		-13		dBm	
Maximum Input Power	P_{MAX}	+0.5			dBm	
Receiver Reflectance	Rrx			-12	dB	
LOS De-Assert	LOS_D			-14	dBm	
LOS Assert	LOS_A	-30			dBm	
LOS Hysteresis	LOS_H	0.5			dB	

Note:
1. 12dB Reflection

Product Datasheet

Diagnostic Monitoring Interface

Digital diagnostics monitoring function is available on all QSFP+ SR4. A 2-wire serial interface provides user to contact with module. The structure of the memory is shown in flowing. The memory space is arranged into a lower, single page, address space of 128 bytes and multiple upper address space pages. This structure permits timely access to addresses in the lower page, such as Interrupt Flags and Monitors. Less time critical time entries, such as serial ID information and threshold settings, are available with the Page Select function. The interface address used is A0xh and is mainly used for time critical data like interrupt handling in order to enable a one-time-read for all data related to an interrupt situation. After an interrupt, IntL, has been asserted, the host can read out the flag field to determine the affected channel and type of flag.



Product Datasheet

Lower Memory Map

Byte Address	Description	Type
0	Identifier (1 Byte)	Read-Only
1-2	Status (2 Bytes)	Read-Only
3-21	Interrupt Flags (19 Bytes)	Read-Only
22-33	Module Monitors (12 Bytes)	Read-Only
34-81	Channel Monitors (48 Bytes)	Read-Only
82-85	Reserved (4 Bytes)	Read-Only
86-97	Control (12 Bytes)	Read/Write
98-99	Reserved (2 Bytes)	Read/Write
100-106	Module and Channel Masks (7 Bytes)	Read/Write
107-118	Reserved (12 Bytes)	Read/Write
119-122	Password Change Entry Area (optional) (4 Bytes)	Read/Write
123-126	Password Entry Area (optional) (4 Bytes)	Read/Write
127	Page Select Byte	Read/Write

Upper Memory Map

Byte Address	Description	Type
128-175	Module Thresholds (48 Bytes)	Read-Only
176-223	Channel Thresholds (48 Bytes)	Read-Only
224-225	Reserved (2 Bytes)	Read-Only
226-239	Vendor Specific Channel Controls (14 Bytes)	Read/Write
240-241	Optional Channel Controls (2 Bytes)	Read/Write
242-253	Channel Monitor Masks (12 Bytes)	Read/Write
254-255	Reserved (2 Bytes)	Read/Write

ATGBICS®

Product Datasheet

Serial ID: Data Fields

Address	Size (Bytes)	Name	Description of Base ID Field
Base_ID Fields			
128	1	Identifier	Identifier Type of serial transceiver
129	1	Ext. Identifier	Extended identifier of serial transceiver
130	1	Connector	Code for connector type
131-138	8	Transceiver	Code for electronic compatibility or optical compatibility
139	1	Encoding	Code for serial encoding algorithm
140	1	BR, nominal	Nominal bit rate, units of 100 MBits/s.
141	1	Extended RateSelect Compliance	Tags for Extended RateSelect compliance
142	1	Length(SMF)	Link length supported for SMF fiber in km
143	1	Length (E-50μm)	Link length supported for EBW 50/125 μm fiber, units of 2 m
144	1	Length (50 μm)	Link length supported for 50/125 μm fiber, units of 1 m
145	1	Length (62.5 μm)	Link length supported for 62.5/125 μm fiber, units of 1 m
146	1	Length Copper	Link length supported for copper, units of 1m
147	1	Device Tech	Device technology
148-163	16	Vendor name	ATGBICS
164	1	Extended	Extended Transceiver Codes for InfiniBand
165-167	3	Vendor OUI	QSFP vendor IEEE company ID
168-183	16	Vendor PN	AFBR-79EIDZ-FT1-C
184-185	2	Vendor rev	Revision level for part number provided by vendor (ASCII)
186-187	2	Wavelength	Nominal laser wavelength (Wavelength = value / 20 in nm)
188-189	2	Wavelength Tolerance	Guaranteed range of laser wavelength (+/- value) from Nominal wavelength.(Wavelength Tol. = value/200 in nm)
190	1	Max Case Temp	Maximum Case Temperature in Degrees C.
191	1	CC_BASE	Check code for Base ID Fields (addresses 128-190)
Extended ID Fields			
192-195	4	Options	Rate Select, TX Disable, TX Fault, LOS
196-211	16	Vendor SN	Serial number provided by vendor (ASCII)
212-219	8	Date code	Vendor's manufacturing date code
220	1	Diagnostic Monitoring Type	Indicates which type of diagnostic monitoring is implemented (if any) in the transceiver. Bit 1, 0 Reserved
221	1	Enhanced Options	Indicates which optional enhanced features are implemented in
222	1	Reserved	Reserved
223	1	CC_EXT	Check code for the Extended ID Fields (addresses 192-
Vendor Specific ID Fields			
224-255	32	Vendor Specific	Vendor Specific EEPROM

The detail description of low memory and page00.page03 upper memory please see SFF-8436 document.

Timing for Soft Control and Status Functions

Parameter	Symbol	Max	Unit	Conditions
Initialization Time	t_init	2000	ms	Time from power on1, hot plug or rising edge of Reset until the module is fully functional2
Reset Init Assert Time	t_reset_init	2	μs	A Reset is generated by a low level longer than the minimum reset pulse time present on the ResetL pin.
Serial Bus Hardware Ready Time	t_serial	2000	ms	Time from power on1 until module responds to data transmission over the 2-wire serial bus
Monitor Data Ready Time	t_data	2000	ms	Time from power on1 to data not ready, bit 0 of Byte 2, deasserted and IntL asserted
Reset Assert Time	t_reset	2000	ms	Time from rising edge on the ResetL pin until the module is fully functional2
LPMode Assert Time	ton_LPMode	100	μs	Time from assertion of LPMode (Vin:LPMode =Vih) until module power consumption enters lower Power Level
IntL Assert Time	ton_IntL	200	ms	Time from occurrence of condition triggering IntL until Vout:IntL = Vol
IntL Deassert Time	toff_IntL	500	μs	toff_IntL 500 μs Time from clear on read3 operation of associated flag until Vout:IntL = Voh. This includes deassert times for Rx LOS, Tx Fault and other flag bits.
Rx LOS Assert Time	ton_los	100	ms	Time from Rx LOS state to Rx LOS bit set and IntL asserted
Flag Assert Time	ton_flag	200	ms	Time from occurrence of condition triggering flag to associated flag bit set and IntL asserted
Mask Assert Time	ton_mask	100	ms	Time from mask bit set4 until associated IntL assertion is inhibited
Mask De-assert Time	toff_mask	100	ms	Time from mask bit cleared4 until associated IntlL operation resumes
ModSelL Assert Time	ton_ModSelL	100	μs	Time from assertion of ModSelL until module responds to data transmission over the 2-wire serial bus
ModSelL Deassert Time	toff_ModSelL	100	μs	Time from deassertion of ModSelL until the module does not respond to data transmission over the 2-wire serial bus
Power_over-ride or	ton_Pdown	100	ms	Time from P_Down bit set 4 until module power

Power-set Assert Time				consumption enters lower Power Level
Power_over-ride or Power-set De-assert Time	toff_Pdown	300	ms	Time from P_Down bit cleared4 until the module is fully functional3

Notes:

1. Power on is defined as the instant when supply voltages reach and remain at or above the minimum specified value.
2. Fully functional is defined as IntL asserted due to data not ready bit, bit 0 byte 2 de-asserted.
3. Measured from falling clock edge after stop bit of read transaction.
4. Measured from falling clock edge after stop bit of write transaction.

- Transceiver Block Diagram

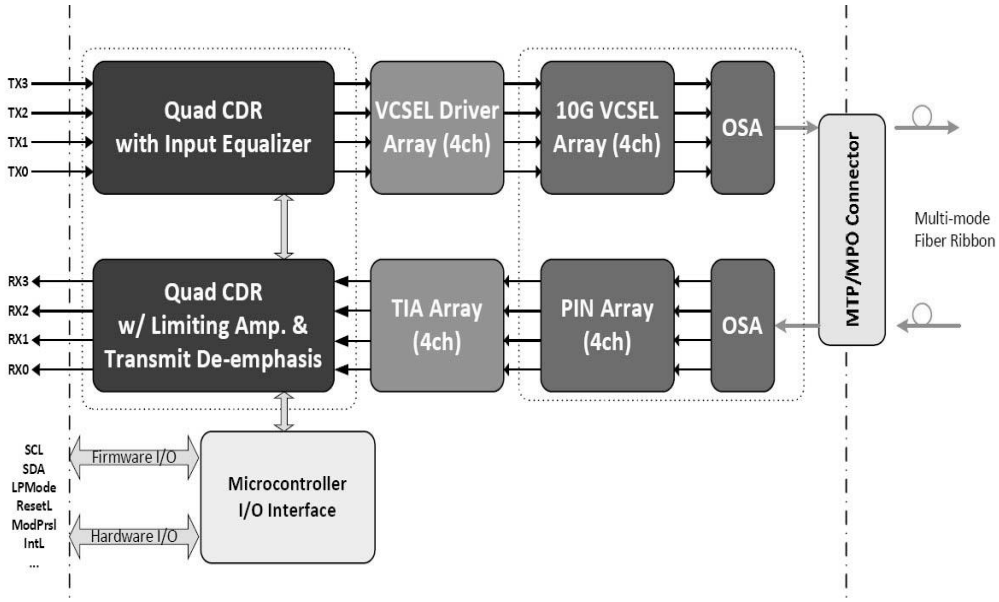


Figure1: Block Diagram

Product Datasheet

Pin Assignment

Diagram of Host Board Connector Block Pin Numbers and Name

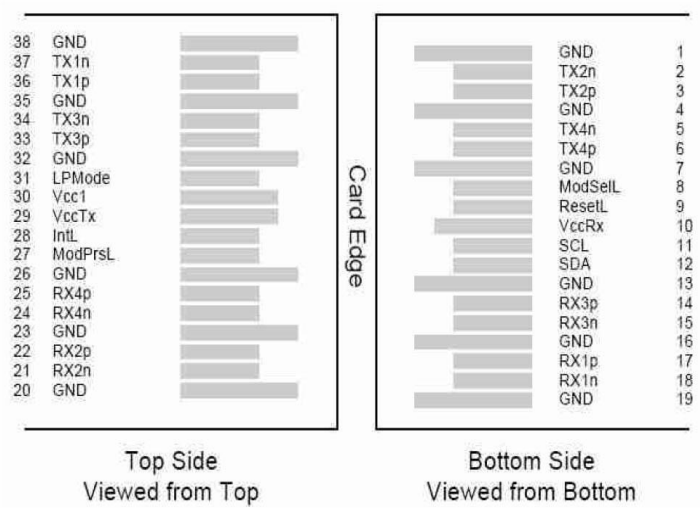


Diagram of Host Board Connector Block Pin Numbers and Names

Pin Function Definitions

Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Ground	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	
3	CML-I	Tx2p	Transmitter Non-Inverted Data output	
4		GND	Ground	1
5	CML-I	Tx4n	Transmitter Inverted Data Output	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Output	
7		GND	Ground	1
8	LVTTL-I	ModSelL	Module Select	
9	LVTTL-I	ResetL	Module Reset	
10		VccRx	+3.3V Power Supply Receiver	2

11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock	
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data	
13		GND	Ground	1
14	CML-O	Rx3p	Receiver Inverted Data Output	
15	CML-O	Rx3n	Receiver Non-Inverted Data Output	
16		GND	Ground	1
17	CML-O	Rx1p	Receiver Inverted Data Output	
18	CML-O	Rx1n	Receiver Non-Inverted Data Output	
19		GND	Ground	1
20		GND	Ground	1
21	CML-O	Rx2n	Receiver Inverted Data Output	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	
23		GND	Ground	1
24	CML-O	Rx4n	Receiver Inverted Data Output	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	
26		GND	Ground	1
27	LVTTL-O	ModPrsL	Module Present	
28	LVTTL-O	IntL	Interrupt	
29		VccTx	+3.3V Power Supply Transmitter	2
30		Vcc1	+3.3V Power Supply	2

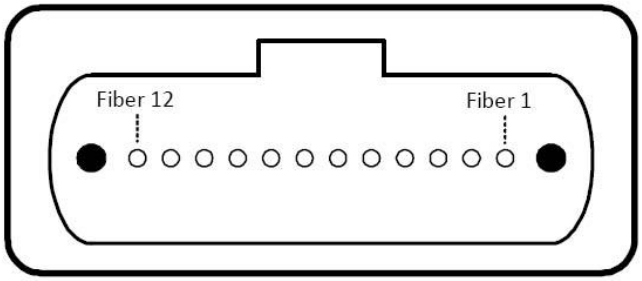
31	LVTTL-I	LPMode	Low Power Mode	
32		GND	Ground	1
33	CML-I	Tx3p	Transmitter Inverted Data Output	
34	CML-I	Tx3n	Transmitter Non-Inverted Data Output	
35		GND	Ground	1
36	CML-I	Tx1p	Transmitter Inverted Data Output	
37	CML-I	Tx1n	Transmitter Non-Inverted Data Output	
38		GND	Ground	1

Notes:

1. GND is the symbol for single and supply(power) common for QSFP modules, All are common within the QSFP module and all module voltages are referenced to this potential otherwise noted. Connect these directly to the host board signal common ground plane. Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
2. VccRx, Vcc1 and VccTx are the receiver and transmitter power suppliers and shall be applied concurrently. Recommended host board power supply filtering is shown below. VccRx, Vcc1 and VccTx may be internally connected within the QSFP transceiver module in any combination. The connector pins are each rated for maximum current of 500mA.

Optical Interface Lanes and Assignment

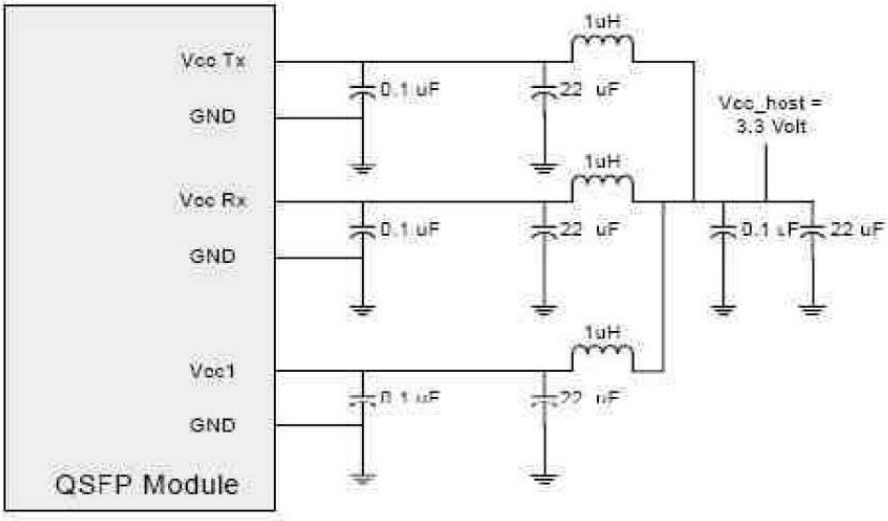
Below figure shows the orientation of the multi-mode fiber facets of the optical connector



Outside View of the QSFP Module MPO

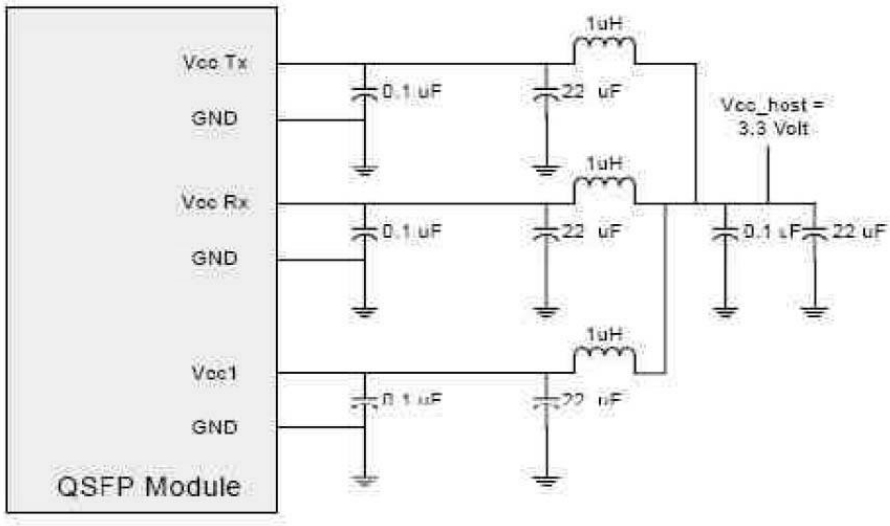
Fiber No.	Lane Assignment
1	RX0
2	RX1
3	RX2
4	RX3
5	Not Used
6	Not Used

Lane Assignment Table



Product Datasheet

Recommended Circuit



QSFP Host Recommended Circuit

Product Datasheet

Mechanical Dimensions